

PS9324L, PS9324L2

R08DS0060EJ0100

Rev.1.00

HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE, 6-PIN SDIP PHOTOCOUPLER

Apr 26, 2013

DESCRIPTION

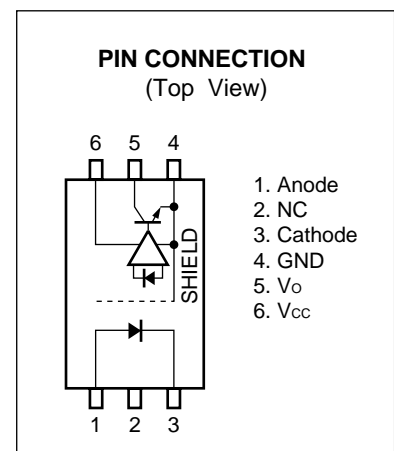
The PS9324L and PS9324L2 are optical coupled high-speed, active low type isolators containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9324L is lead bending type (Gull-wing) for surface mounting.

The PS9324L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

FEATURES

- High common mode transient immunity ($CM_H, CM_L = \pm 15 \text{ kV}/\mu\text{s}$ MIN.)
- Half size of 8-pin DIP
- Long creepage distance (8 mm MIN.: PS9324L2)
- High-speed (10 Mbps)
- High-speed response ($t_{PHL} = 75 \text{ ns}$ MAX., $t_{PLH} = 75 \text{ ns}$ MAX.)
- Low power consumption ($V_{CC} = 3.3/5 \text{ V}$)
- Open collector output
- High isolation voltage ($BV = 5\,000 \text{ Vr.m.s.}$)
- Embossed tape product : PS9324L-E3 : 2 000 pcs/reel
: PS9324L2-E3: 2 000 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
 - SEMKO approved (EN 60065, EN 60950)
 - DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

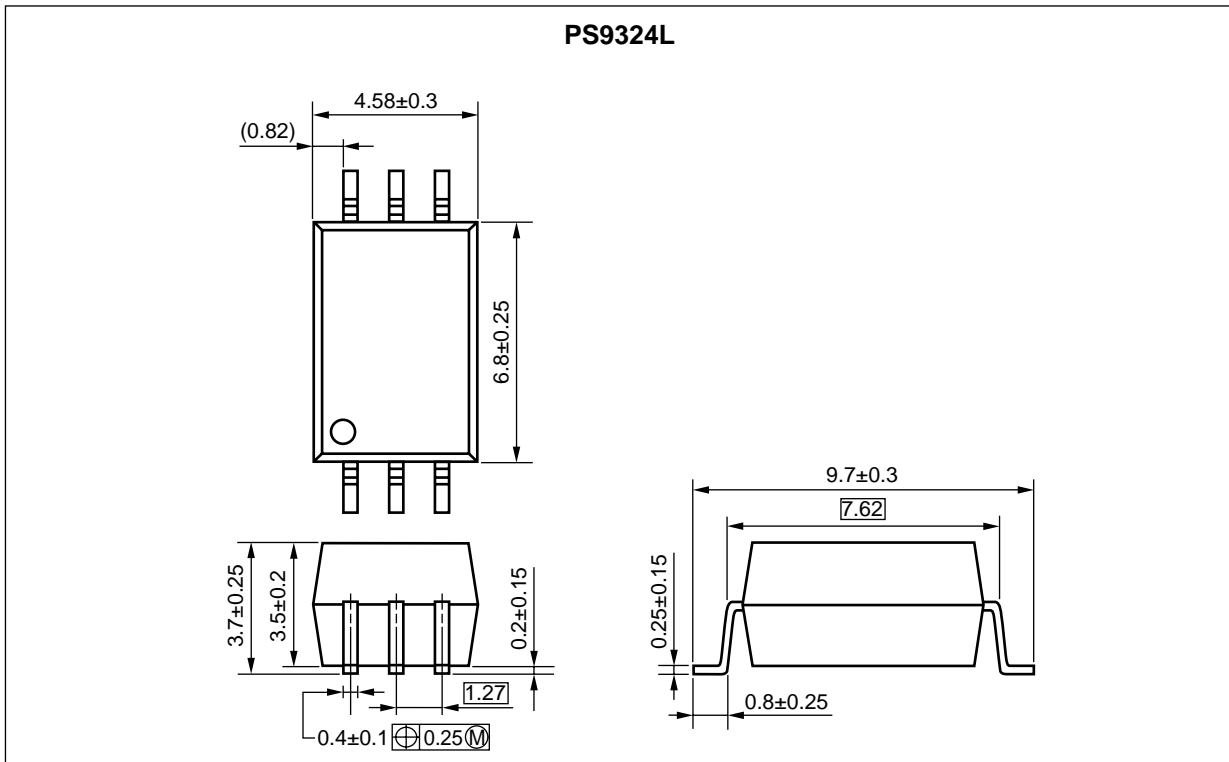


APPLICATIONS

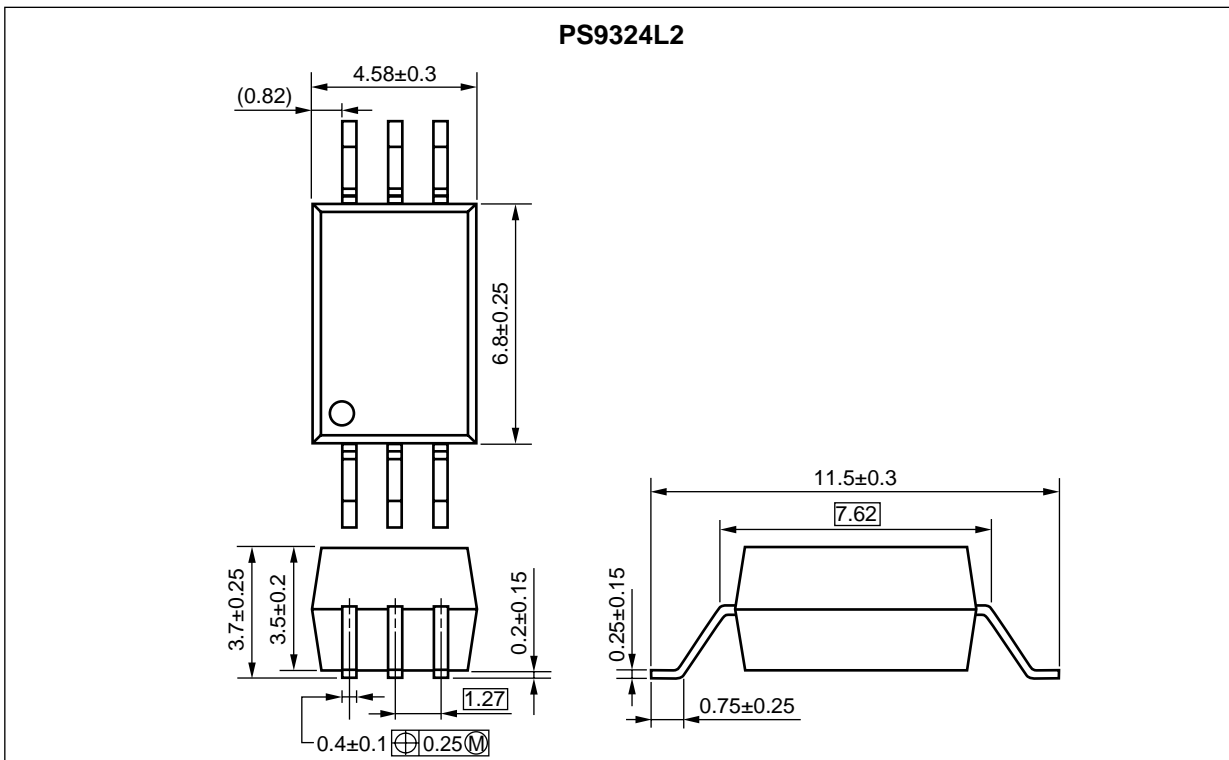
- Measurement equipment
- PDP
- FA Network

PACKAGE DIMENSIONS (UNIT: mm)

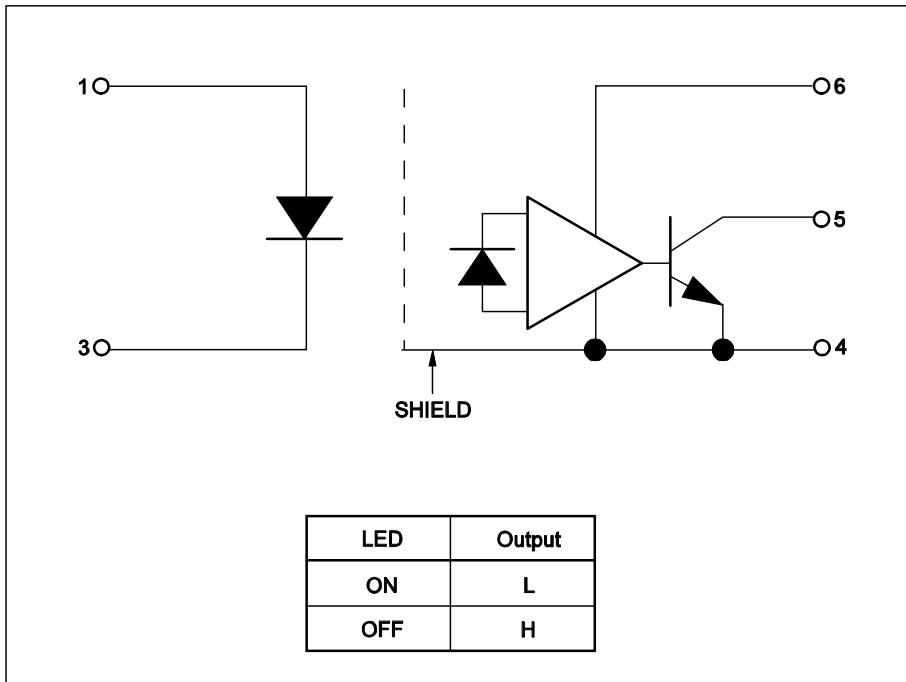
Lead Bending Type (Gull-wing) For Surface Mount



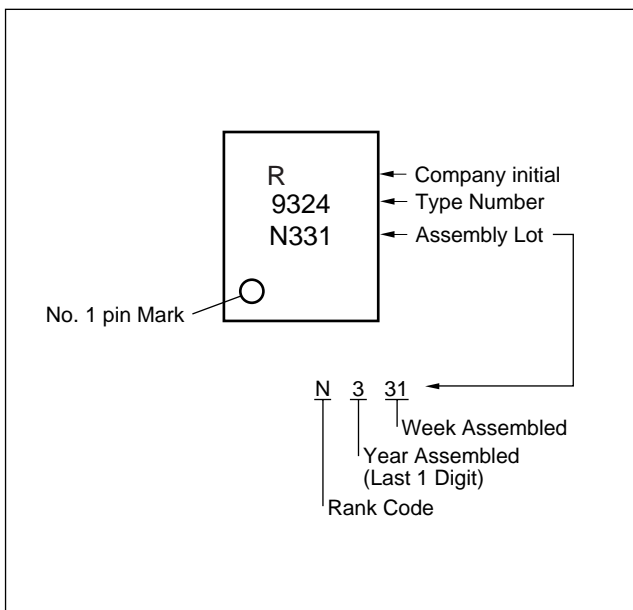
Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



BLOCK DIAGRAM



MARKING EXAMPLE



PHOTOCOUPLER CONSTRUCTION

| Parameter | PS9324L | PS9324L2 |
|--------------------------------|---------|----------|
| Air Distance (MIN.) | 7 mm | 8 mm |
| Outer Creepage Distance (MIN.) | 7 mm | 8 mm |
| Isolation Distance (MIN.) | 0.4 mm | 0.4 mm |

ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number*1 |
|---------------|------------------|------------------------------|---------------------------------|---|---------------------------|
| PS9324L | PS9324L-AX | Pb-Free (Ni/Pd/Au) | 20 pcs (Tape 20 pcs cut) | Standard products UL, CSA ,SEMKO approval) | PS9324L |
| PS9324L-E3 | PS9324L-E3-AX | | Embossed Tape 2 000 pcs/reel | | |
| PS9324L2 | PS9324L2-AX | | 20 pcs (Tape 20 pcs cut) | Standard products UL, CSA ,SEMKO approval) | PS9324L2 |
| PS9324L2-E3 | PS9324L2-E3-AX | | Embossed Tape 2 000 pcs/reel | | |
| PS9324L-V | PS9324L-V-AX | | 20 pcs (Tape 20 pcs cut) | DIN EN 60747-5-5 (VDE 0884-5) Approved (Option) | PS9324L |
| PS9324L-V-E3 | PS9324L-V-E3-AX | | Embossed Tape 2 000 pcs/reel | | |
| PS9324L2-V | PS9324L2-V-AX | | 20 pcs (Tape 20 pcs cut) | DIN EN 60747-5-5 (VDE 0884-5) Approved (Option) | PS9324L2 |
| PS9324L2-V-E3 | PS9324L2-V-E3-AX | | Embossed Tape 2 000 pcs/reel | | |

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|-------------------------------|----------------------|------------------|-------------|---------|
| Diode | Forward Current *1 | I _F | 25 | mA |
| | Reverse Voltage | V _R | 5 | V |
| Detector | Supply Voltage | V _{CC} | 7 | V |
| | Output Voltage | V _O | 7 | V |
| | Output Current | I _O | 25 | mA |
| | Power Dissipation *2 | P _C | 200 | mW |
| Isolation Voltage *3 | | BV | 5 000 | Vr.m.s. |
| Operating Ambient Temperature | | T _A | -40 to +110 | °C |
| Storage Temperature | | T _{stg} | -55 to +125 | °C |

Notes: *1. Reduced to 0.2 mA/°C at T_A = 25°C or more.

*2. Reduced to 4.0 mW/°C at T_A = 75°C or more.

*3 AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.

Pins 1-3 shorted together, 4-6 shorted together.

RECOMMENDED OPERATING CONDITIONS

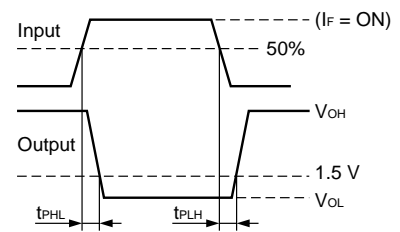
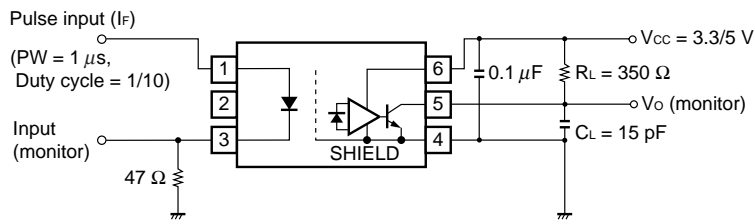
| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|------------------------------------|-----------------|------|------|------|------|
| Low Level Input Current | V _{FL} | 0 | | 0.8 | V |
| High Level Input Current | I _{FH} | 3.8 | 6 | 7.5 | mA |
| Supply Voltage | V _{CC} | 2.7 | | 5.5 | V |
| TTL (R _L = 1 kΩ, loads) | N | | | 5 | |
| Pull-up Resistor | R _L | 330 | | 4k | Ω |

ELECTRICAL CHARACTERISTICS (T_A = -40 to +110°C, unless otherwise specified)

| Parameter | | Symbol | Conditions | MIN. | TYP. ^{*1} | MAX. | Unit | |
|---|---|---|---|-----------------------|--------------------|-------|------|----|
| Diode | Forward Voltage | V _F | I _F = 10 mA, T _A = 25°C | 1.3 | 1.55 | 1.8 | V | |
| | Reverse Current | I _R | V _R = 3 V, T _A = 25°C | | | 10 | μA | |
| | Terminal Capacitance | C _t | f = 1 MHz, V _F = 0 V, T _A = 25°C | | 30 | | pF | |
| Detector | High Level Output Current | I _{OH} | V _{CC} = V _O = 3.3 V, V _F = 0.8 V | | 1 | 80 | μA | |
| | | | V _{CC} = V _O = 5.5 V, V _F = 0.8 V | | 1 | 100 | | |
| | Low Level Output Voltage | V _{OL} | V _{CC} = 3.3 V, I _F = 4.5 mA, I _{OL} = 13 mA | | 0.2 | 0.6 | V | |
| | | | V _{CC} = 5.5 V, I _F = 4.5 mA, I _{OL} = 13 mA | | | | | |
| | High Level Supply Current | I _{CCH} | V _{CC} = 3.3 V, I _F = 0 mA, V _O = open | | 4 | 7 | mA | |
| | | | V _{CC} = 5.5 V, I _F = 0 mA, V _O = open | | | | | |
| Low Level Supply Current | I _{CCL} | V _{CC} = 3.3 V, I _F = 4.5 mA, V _O = open | | 6 | 10 | mA | | |
| | | V _{CC} = 5.5 V, I _F = 4.5 mA, V _O = open | | | | | | |
| Coupled | Threshold Input Voltage (H → L) | I _{FHL} | V _{CC} = 3.3 V, R _L = 350 Ω, V _O = 0.8 V | | 1 | 3 | mA | |
| | | | V _{CC} = 5.0 V, R _L = 350 Ω, V _O = 0.8 V | | | | | |
| | Isolation Resistance | R _{I-O} | V _{I-O} = 1 kV _{DC} , RH = 40 to 60% | 10 ¹¹ | | | Ω | |
| | Isolation Capacitance | C _{I-O} | V _{I-O} = 0 V, f = 1 MHz, T _A = 25°C | | 0.6 | | pF | |
| | Propagation Delay Time (H → L) ^{*2} | t _{PHL} | V _{CC} = 3.3 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | T _A = 25°C | | 40 | 75 | ns |
| | | | | | | | 100 | |
| | | | V _{CC} = 5 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | T _A = 25°C | | 40 | 75 | |
| | | | | | | | 100 | |
| | Propagation Delay Time (L → H) ^{*2} | t _{PLH} | V _{CC} = 3.3 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | T _A = 25°C | | 50 | 75 | ns |
| | | | | | | | 100 | |
| | | | V _{CC} = 5 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | T _A = 25°C | | 45 | 75 | |
| | | | | | | | 100 | |
| | Pulse Width Distortion (PWD) ^{*2} | t _{PHL} , t _{PLH} | V _{CC} = 3.3/5 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | | 5 | 35 | ns | |
| Propagation Delay Skew ^{*2} | t _{psk} | V _{CC} = 3.3/5 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | | | 40 | ns | | |
| Rise Time ^{*3} | t _r | V _{CC} = 3.3/5 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | | 20 | | ns | | |
| Fall Time ^{*3} | t _f | V _{CC} = 3.3/5 V, I _F = 4.5 mA, R _L = 350 Ω, C _L = 15 pF | | 5 | | ns | | |
| Common Mode Transient Immunity at High Level Output ^{*4} | CM _H | V _{CC} = 3.3/5 V, I _F = 0 mA, V _O > 2 V, R _L = 350 Ω, V _{CM} = 1.5 kV, T _A = 25°C | 15 | 20 | | kV/μs | | |
| Common Mode Transient Immunity at Low Level Output ^{*4} | CM _L | V _{CC} = 3.3/5 V, I _F = 4.5 mA, V _O < 0.8 V, R _L = 350 Ω, V _{CM} = 1.5 kV, T _A = 25°C | 15 | 20 | | kV/μs | | |

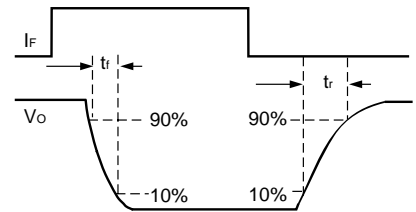
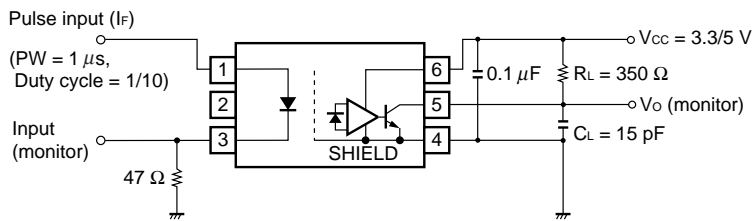
Notes: *1. Typical values at $T_A = 25^\circ\text{C}$

*2. Test circuit for propagation delay time



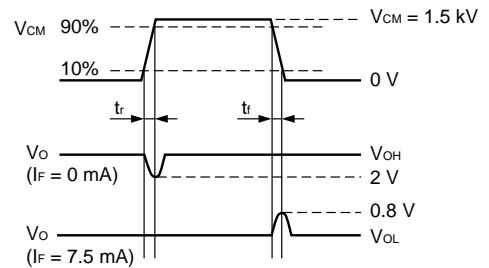
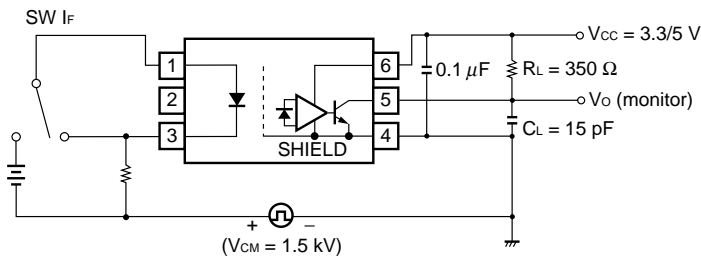
Remark C_L includes probe and stray wiring capacitance.

*3. Test circuit for switching time



Remark C_L includes probe and stray wiring capacitance.

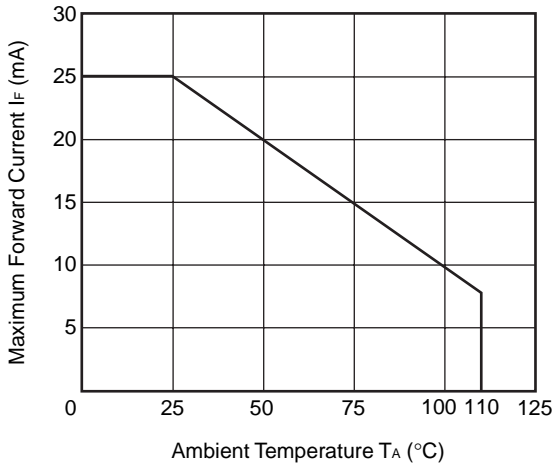
*4. Test circuit for common mode transient immunity



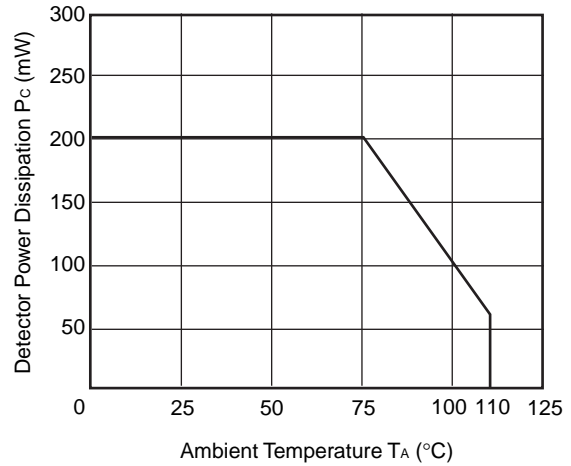
Remark C_L includes probe and stray wiring capacitance.

TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

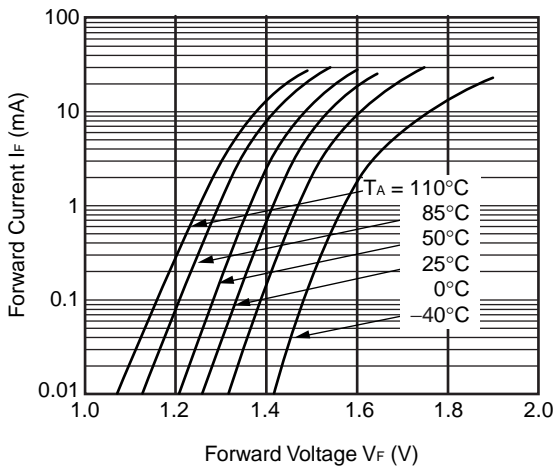
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



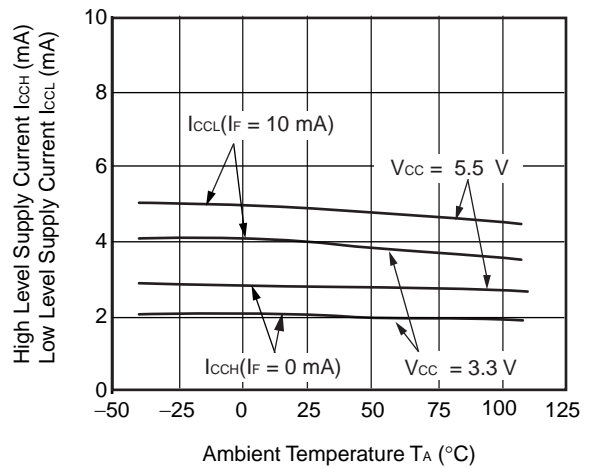
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



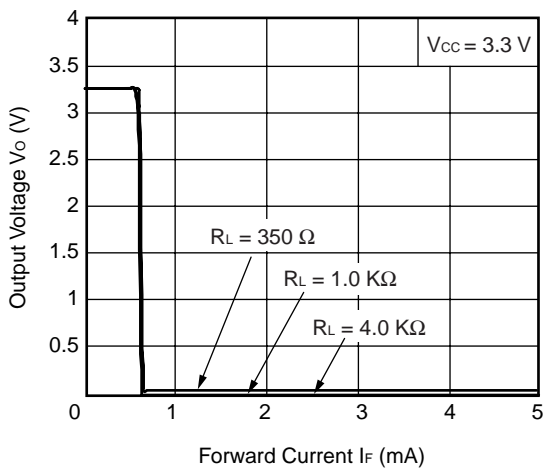
FORWARD CURRENT vs. FORWARD VOLTAGE



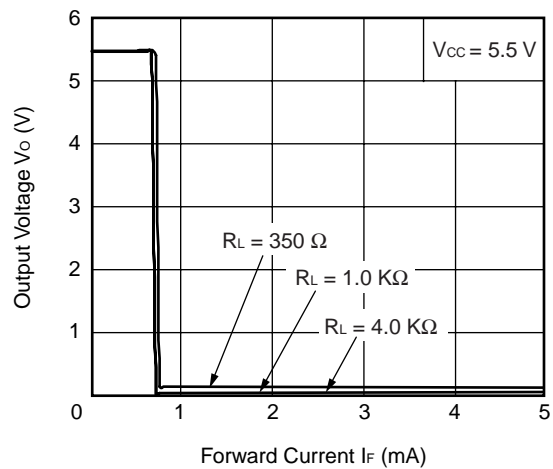
SUPPLY CURRENT vs. AMBIENT TEMPERATURE



OUTPUT VOLTAGE vs. FORWARD CURRENT

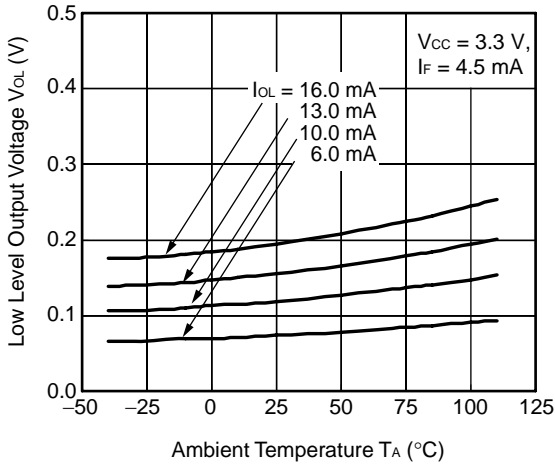


OUTPUT VOLTAGE vs. FORWARD CURRENT

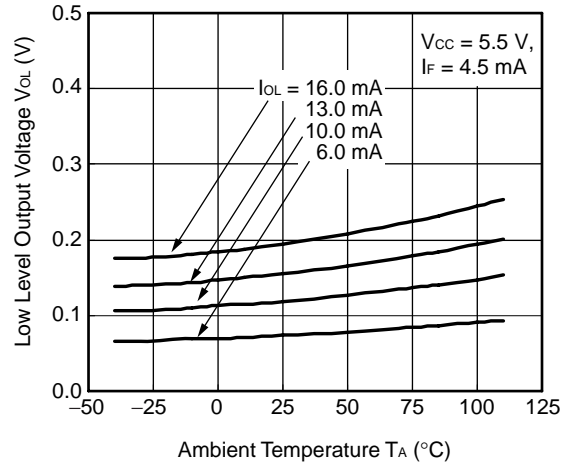


Remark The graphs indicate nominal characteristics.

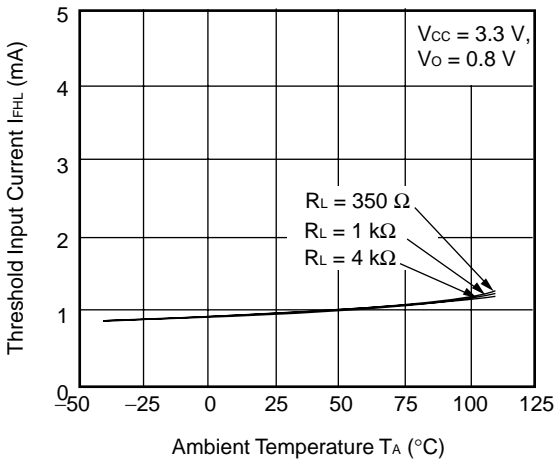
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



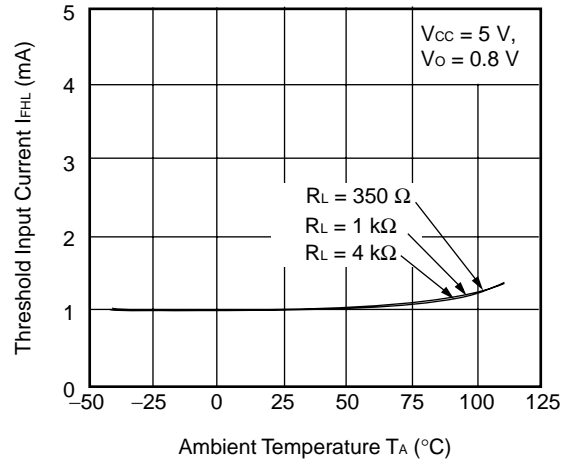
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



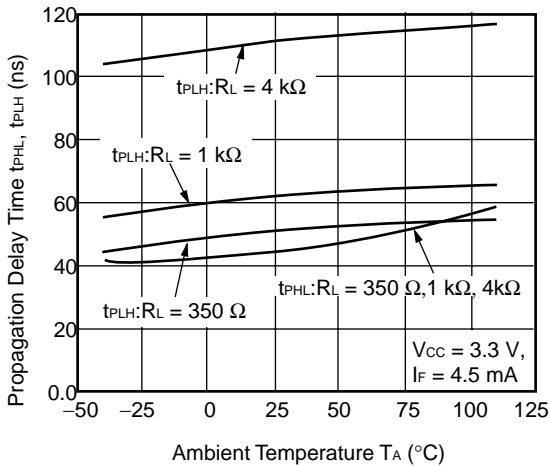
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



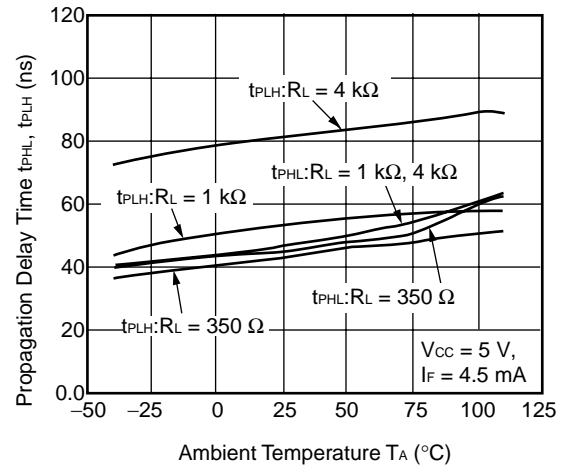
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE

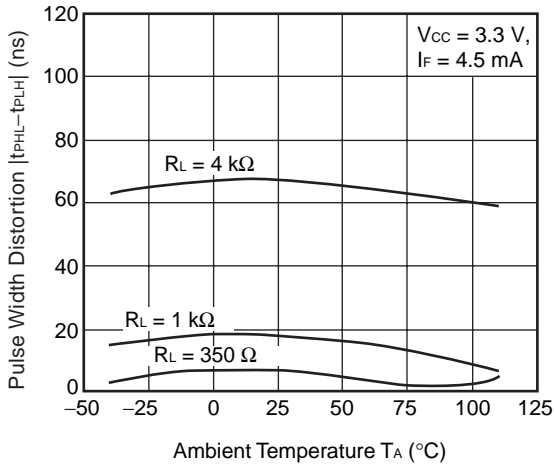


PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE

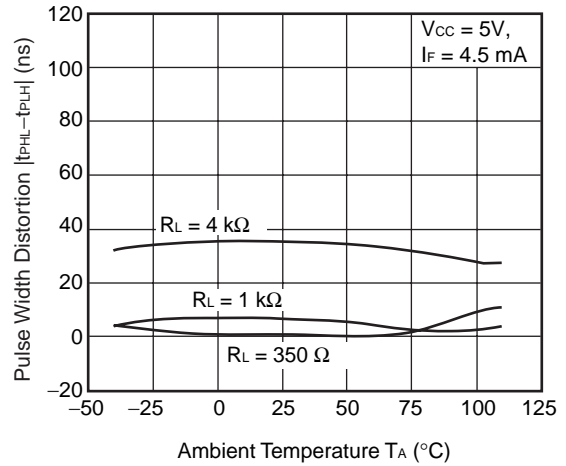


Remark The graphs indicate nominal characteristics.

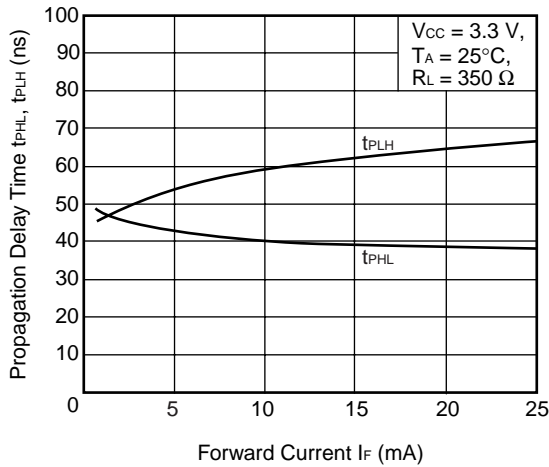
PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



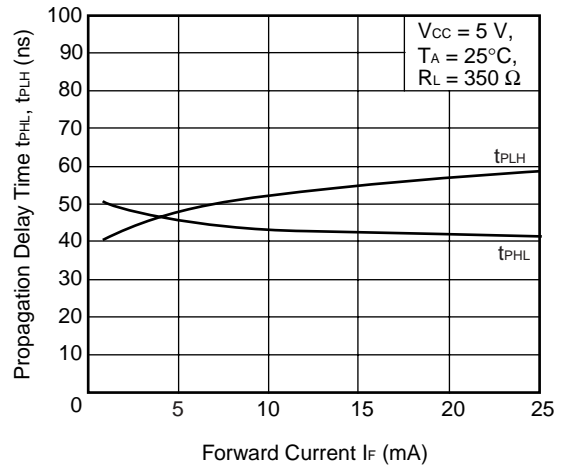
PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



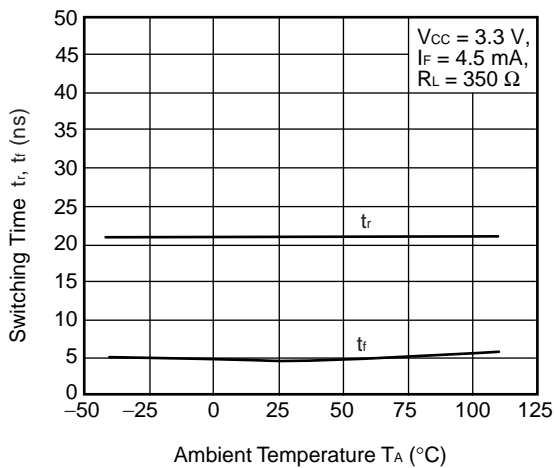
PROPAGATION DELAY TIME vs. FORWARD CURRENT



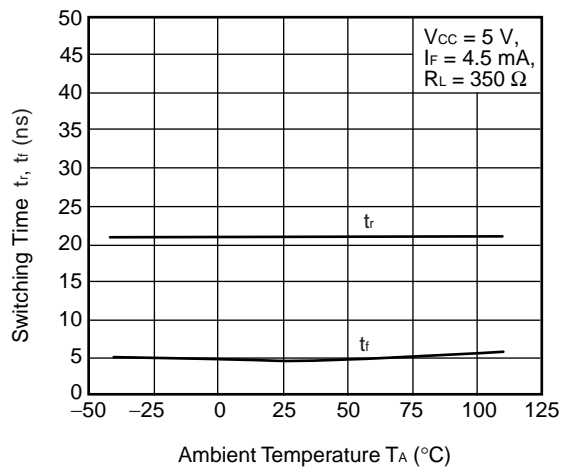
PROPAGATION DELAY TIME vs. FORWARD CURRENT



SWITCHING TIME vs. AMBIENT TEMPERATURE

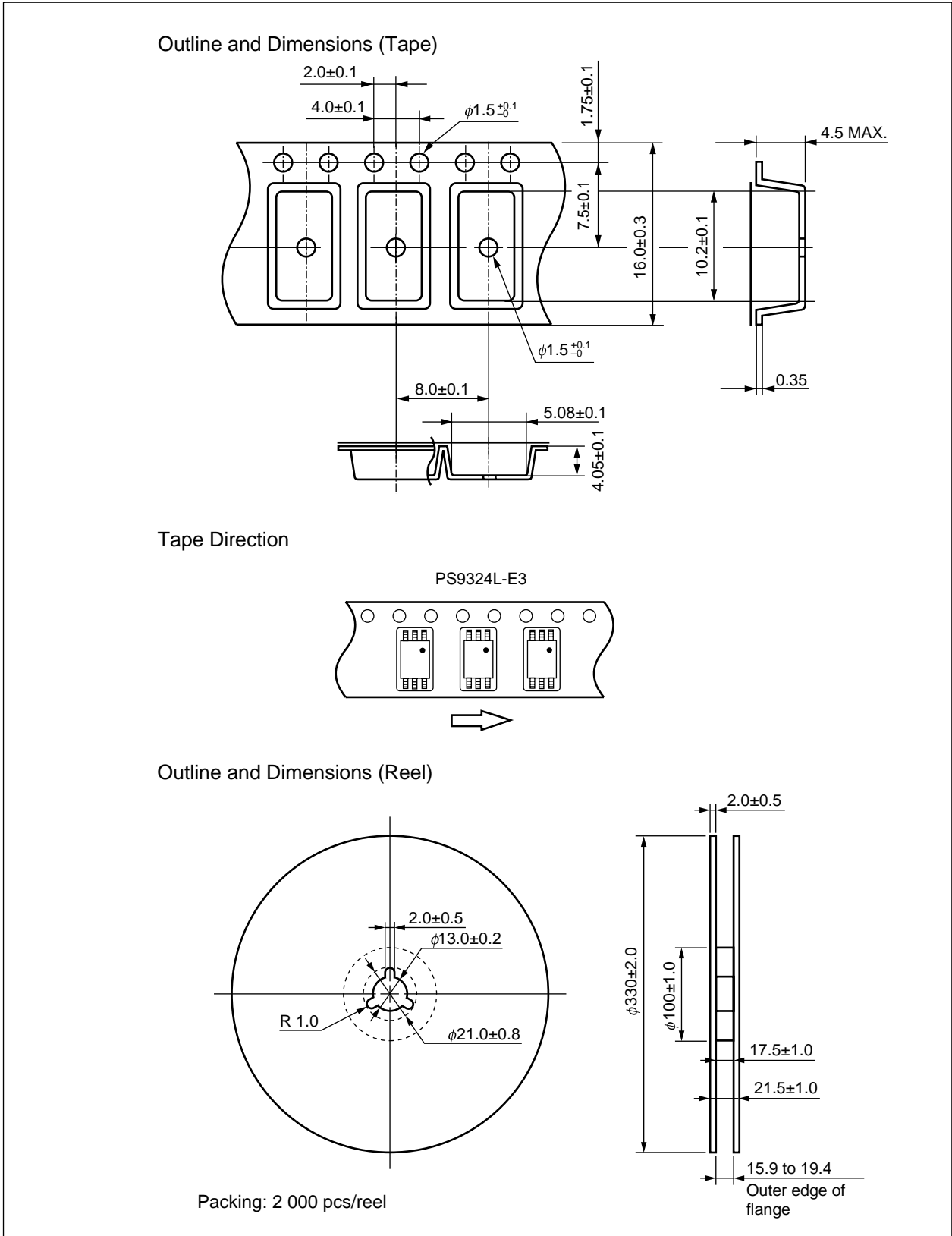


SWITCHING TIME vs. AMBIENT TEMPERATURE

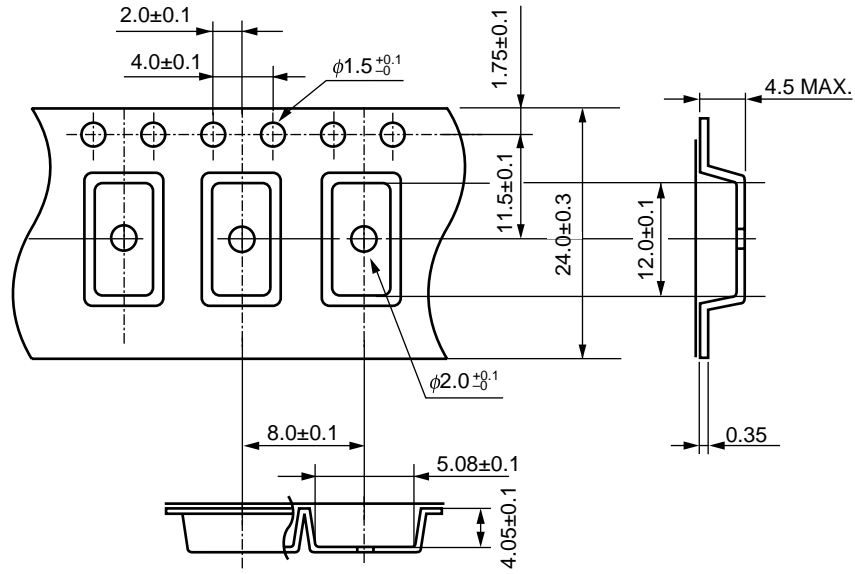


Remark The graphs indicate nominal characteristics.

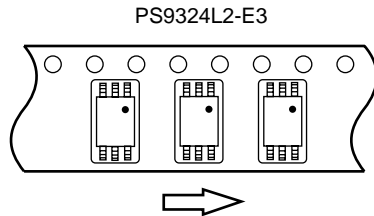
TAPING SPECIFICATIONS (UNIT: mm)



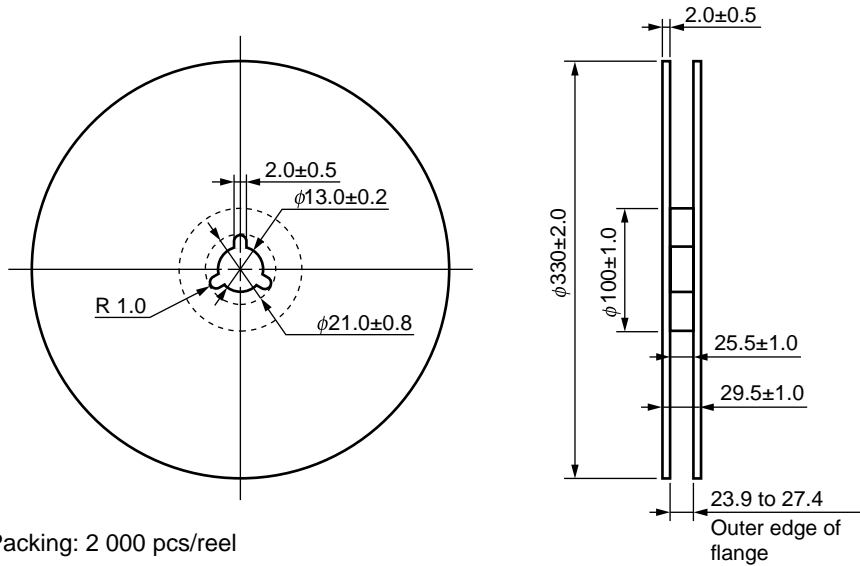
Outline and Dimensions (Tape)



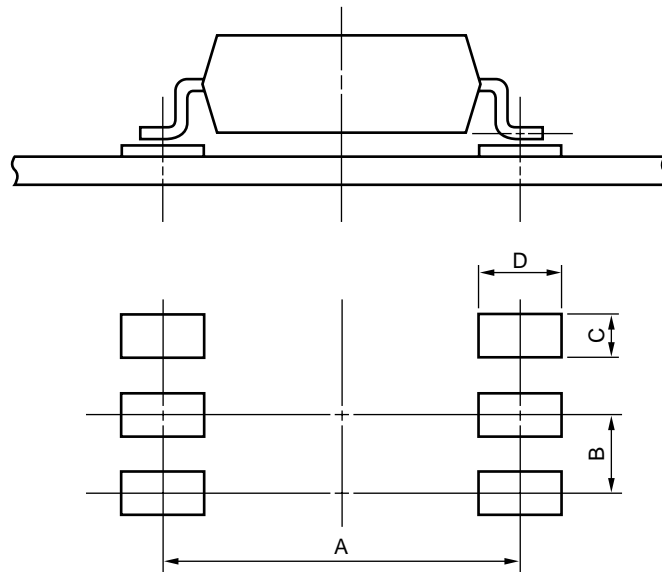
Tape Direction



Outline and Dimensions (Reel)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



| Part Number | Lead Bending | A | B | C | D |
|-------------|---|------|------|-----|-----|
| PS9324L | lead bending type (Gull-wing) for surface mount | 9.2 | 1.27 | 0.8 | 2.2 |
| PS9324L2 | lead bending type (Gull-wing) for long creepage distance (surface mount) | 10.2 | 1.27 | 0.8 | 2.2 |

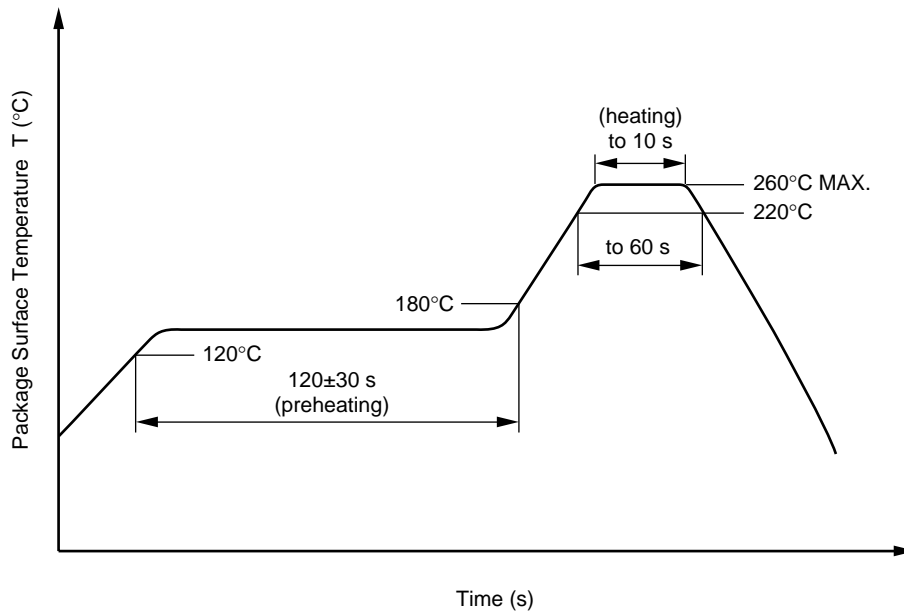
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pin) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of more than 0.1 μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
3. When V_{DD} is lower than around 2 V, the output(V_O) of this product is unstable, and this might produce undesirable operation. Be sure to check the operation of an IC or a discrete component that is connected to this product during Power-up and Power-down process. And we recommend to use a disable function (shutdown function) of the connected IC or a reset IC to avoid this undesirable operation.
4. Pin 2 (which is an NC*1 pin) can either be connected directly to the GND pin on the LED side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.
Note: *1. NC: Non-Connection (No Connection).
5. Avoid storage at a high temperature and high humidity.

SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Spec. | Unit |
|--|----------------------|------------------------|----------------------|
| Climatic test class (IEC 60068-1/DIN EN 60068-1) | | 40/110/21 | |
| Dielectric strength maximum operating isolation voltage | U_{IORM} | 1 130 | V_{peak} |
| Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{IORM}$, $P_d < 5$ pC | U_{pr} | 1 808 | V_{peak} |
| Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM}$, $P_d < 5$ pC | U_{pr} | 2 119 | V_{peak} |
| Highest permissible overvoltage | U_{TR} | 8 000 | V_{peak} |
| Degree of pollution (DIN EN 60664-1 VDE0110 Part 1) | | 2 | |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11)) | CTI | 175 | |
| Material group (DIN EN 60664-1 VDE0110 Part 1) | | III a | |
| Storage temperature range | T_{stg} | -55 to +125 | °C |
| Operating temperature range | T_A | -40 to +110 | °C |
| Isolation resistance, minimum value $V_{IO} = 500$ V dc at $T_A = 25^\circ\text{C}$ $V_{IO} = 500$ V dc at T_A MAX. at least 100°C | Ris MIN. Ris MIN. | 10^{12} 10^{11} | Ω Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) | | | |
| Package temperature | T_{si} | 175 | °C |
| Current (input current I_F , $P_{si} = 0$) | I_{si} | 400 | mA |
| Power (output or total power dissipation) | P_{si} | 700 | mW |
| Isolation resistance $V_{IO} = 500$ V dc at $T_A = T_{si}$ | Ris MIN. | 10^9 | Ω |

| | | |
|----------------|---------------|--|
| Caution | GaAs Products | <p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none">• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.<ol style="list-style-type: none">1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.• Do not burn, destroy, cut, crush, or chemically dissolve the product.• Do not lick the product or in any way allow it to enter the mouth. |
|----------------|---------------|--|

| | |
|-------------------------|-------------------------------------|
| Revision History | PS9324L, PS9324L2 Data Sheet |
|-------------------------|-------------------------------------|

| Rev. | Date | Description | |
|-------------|--------------|--------------------|----------------------|
| | | Page | Summary |
| 1.00 | Apr 26, 2013 | - | First Edition Issued |

All trademarks and registered trademarks are the property of their respective owners.

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
3. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product.
5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.
"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc.
Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas Electronics.
6. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
10. It is the responsibility of the buyer or distributor of Renesas Electronics products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the contents and conditions set forth in this document, Renesas Electronics assumes no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
11. This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.
(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.
(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.



SALES OFFICES

Renesas Electronics Corporation

<http://www.renesas.com>

Refer to "<http://www.renesas.com/>" for the latest and detailed information.

California Eastern Laboratories, Inc.
4590 Patrick Henry Drive, Santa Clara, California 95054, U.S.A.
Tel: +1-408-919-2500, Fax: +1-408-988-0279

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China
Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd.
11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5141

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Renesas Electronics:](#)

[PS9324L2-E3-AX](#) [PS9324L-E3-AX](#) [PS9324L-V-E3-AX](#) [PS9324L2-AX](#) [PS9324L2-V-E3-AX](#)

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А